

MAXIMUM RATINGS

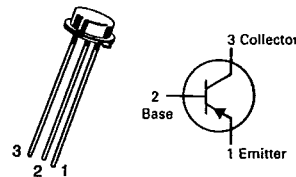
Rating	Symbol	2N2945A	2N2946A	Unit
Emitter-Collector Voltage	V_{ECO}	20	35	Vdc
Collector-Base Voltage	V_{CBO}	25	40	Vdc
Emitter-Base Voltage	V_{EBO}	25	40	Vdc
Collector Current — Continuous	I_C	100		mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	400 2.3		mW mW/°C
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	2.0 11.43		Watts mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		°C
Lead Temperature 1/16" from Case for 10 seconds	T_L	240		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	435	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	87.5	°C/W

2N2945A
2N2946A

JAN, JTX, JTXV AVAILABLE
CASE 26-03, STYLE 1
TO-46 (TO-206AB)



CHOPPER TRANSISTORS

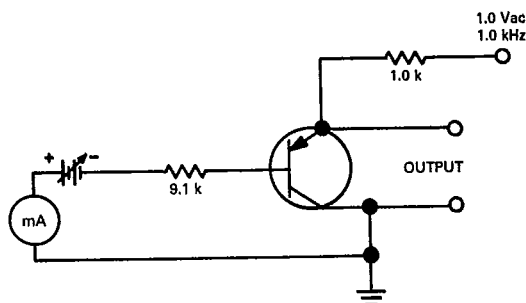
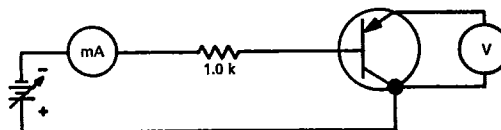
PNP SILICON

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Emitter-Collector Breakdown Voltage ($I_E = 10 \mu\text{Adc}$, $I_B = 0$)	$V_{(BR)ECO}$	20 35	— —	— —	Vdc
Collector Cutoff Current ($V_{CB} = 25 \text{ Vdc}$, $I_E = 0$) ($V_{CB} = 40 \text{ Vdc}$, $I_E = 0$) ($V_{CB} = 25 \text{ Vdc}$, $I_E = 0$, $T_A = 100^\circ\text{C}$) ($V_{CB} = 40 \text{ Vdc}$, $I_E = 0$, $T_A = 100^\circ\text{C}$)	I_{CBO}	— — — —	— — — —	0.2 0.5 20 25	nAdc
Emitter Cutoff Current ($V_{EB} = 25 \text{ Vdc}$, $I_C = 0$) ($V_{EB} = 40 \text{ Vdc}$, $I_C = 0$) ($V_{EB} = 25 \text{ Vdc}$, $I_C = 0$, $T_A = 100^\circ\text{C}$) ($V_{EB} = 40 \text{ Vdc}$, $I_C = 0$, $T_A = 100^\circ\text{C}$)	I_{EBO}	— — — —	— — — —	0.2 0.5 15 20	nAdc
ON CHARACTERISTICS					
DC Current Gain ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 0.5 \text{ Vdc}$)	h_{FE}	70 50	200 200	— —	—
DC Current Gain (Inverted Connection) ($I_B = 200 \mu\text{Adc}$, $V_{EC} = 0.5 \text{ Vdc}$)	$h_{FE(inv)}$	30 20	32 25	— —	—
Offset Voltage ($I_B = 200 \mu\text{Adc}$, $I_E = 0$) ($I_B = 1.0 \text{ mAdc}$, $I_E = 0$) ($I_B = 2.0 \text{ mAdc}$, $I_E = 0$)	$V_{EC(ofs)}$	— — —	0.4 0.7 0.5 0.6	0.5 0.8 1.0 2.0	mVdc
		— —	0.9 1.0	1.5 2.5	

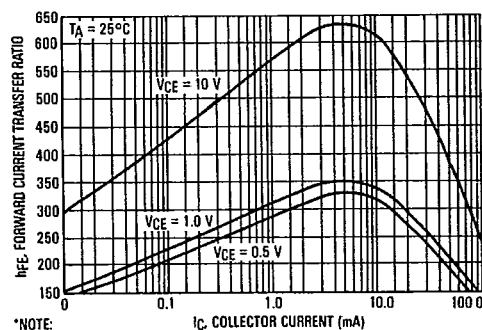
SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product ($I_C = 1.0$ mA, $V_{CE} = 6.0$ Vdc, $f = 1.0$ MHz)	2N2945A 2N2946A	f_T	10 5.0	15 8.0	— —	MHz
Output Capacitance ($V_{CB} = 6.0$ Vdc, $I_E = 0$, $f = 0.1$ MHz to 1.0 MHz)		C_{obo}	—	3.2	10	pF
Input Capacitance ($V_{EB} = 6.0$ Vdc, $I_C = 0$, $f = 0.1$ MHz to 1.0 MHz)		C_{ibo}	—	1.9	6.0	pF
"ON" Series Resistance ($I_B = 1.0$ mA, $I_E = 0$, $I_B = 100$ μ A rms, $f = 1.0$ kHz)	2N2945A 2N2946A	$r_{ec(on)}$	— —	5.0 7.0	6.0 8.0	Ohms

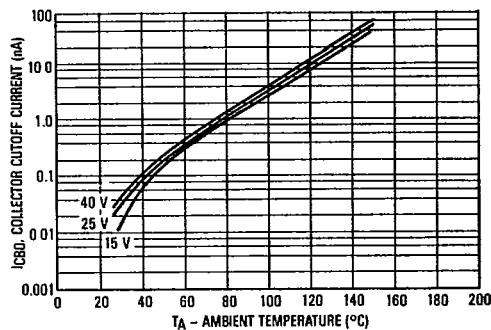
FIGURE 1 — $V_{EC(on)}$ FIGURE 2 — $V_{EC(offset)}$ 

mA + + + + - - - - 9.1 k 2% 1.0 Vdc
 10 k 2% Output Figure 1 — $r_{ec(on)}$ $r_{ec(on)}$ $r_{ec(on)}$
 mA 1.0k 2% V
 Output measured with H.P. 400D
 Ac VTVM or equivalent.
 1.0 mV = 1.0 Ω $r_{ec(on)}$

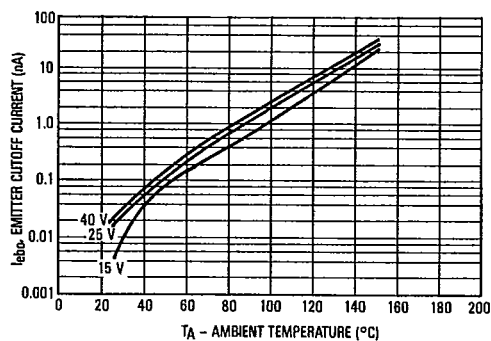
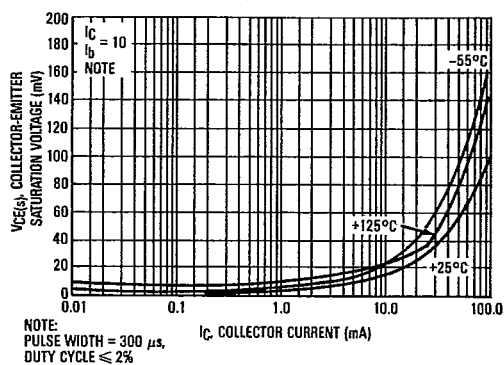
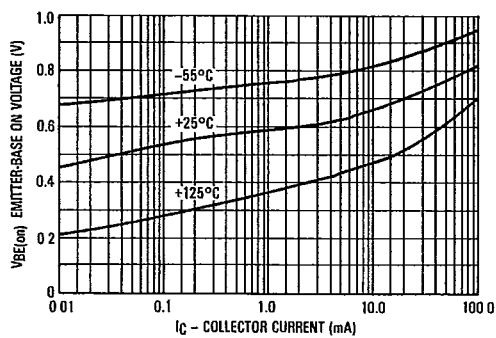
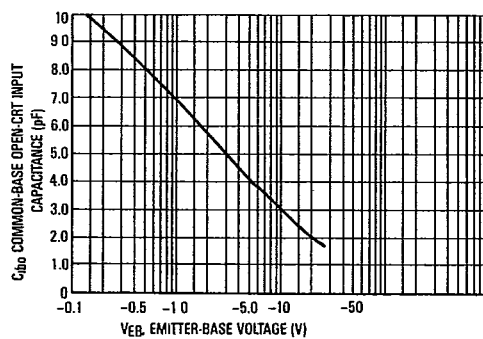
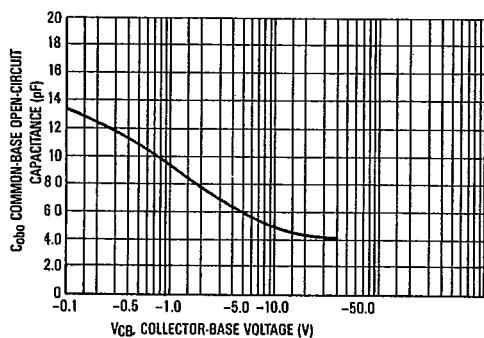
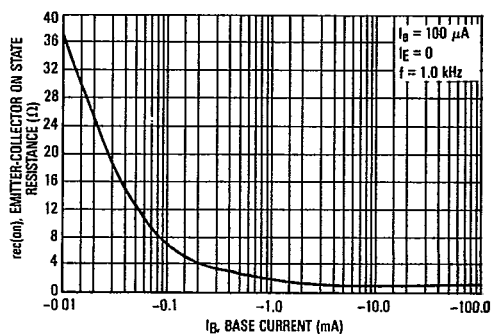
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 h_{FE} versus I_C 

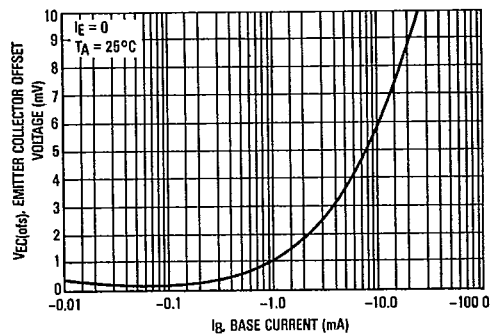
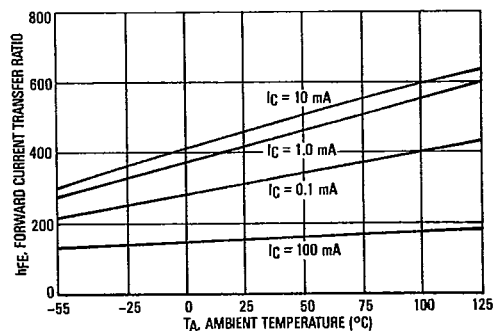
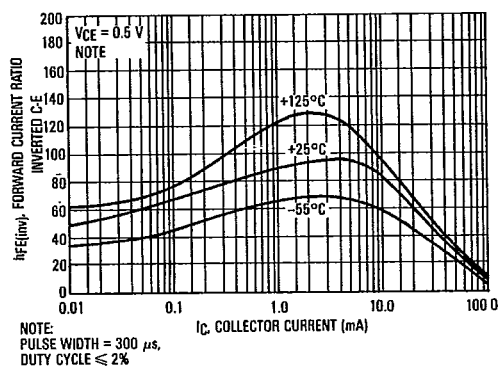
*NOTE:
 PULSE WIDTH = 300 μ s,
 DUTY CYCLE $\leq$ 2%

 I_{CBO} versus T_A 

T-37-23

 I_{ebo} versus T_A  $V_{CE(s)}$ versus I_C  $V_{BE(on)}$ versus I_C  C_{ibo} versus V_{EB}  C_{obo} versus V_{CB}  $r_{ec(on)}$ versus I_B 

T-37-23

 $V_{EC(ofs)}$ versus I_B  h_{FE} versus T_A  $h_{FE(inv)}$ versus I_C 

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